

FDMS8460 N-Channel Power Trench[®] MOSFET 40V, 49A, 2.2mΩ

Features

- Max $r_{DS(on)}$ = 2.2m Ω at V_{GS} = 10V, I_D = 25A
- Max r_{DS(on)} = 3.0mΩ at V_{GS} = 4.5V, I_D = 21.7A
- Advanced Package and Silicon combination for low r_{DS(on)}
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

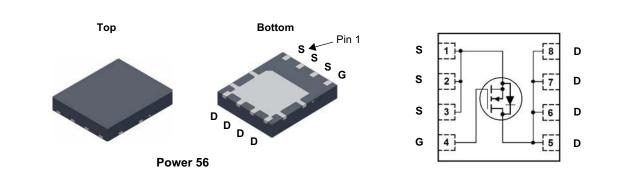


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process thant has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Application

DC - DC Conversion



MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			40	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous (Package limited)	T _C = 25°C		49		
I _D	-Continuous (Silicon limited)	T _C = 25°C		167		
	-Continuous	T _A = 25°C	(Note 1a)	25	A	
	-Pulsed			160		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	864	mJ	
P _D	Power Dissipation	T _C = 25°C		104		
	Power Dissipation $T_A = 25^{\circ}C$ (Note 1a)		(Note 1a)	2.5	W	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.2	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a	a) 50	0/00

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS8460	FDMS8460	Power 56	13"	12 mm	3000 units

December 2012

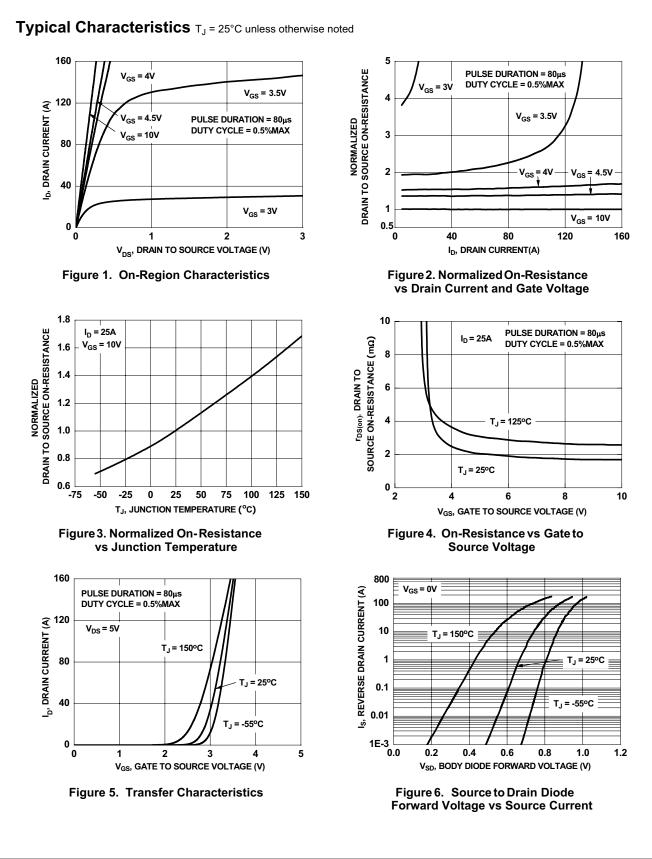
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	40			V	
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C		32		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{GS} = 0V, V _{DS} = 32V,			1	μA	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA	
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	1.0	1.9	3.0	V	
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage		1.0		0.0		
ΔT_J	Temperature Coefficient	$I_D = 250 \mu A$, referenced to $25^{\circ}C$		-7.5		mV/°0	
		V _{GS} = 10V, I _D = 25A		2.0	2.2		
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 4.5V, I _D = 21.7A		2.6	3.0		
		V _{GS} = 10V, I _D = 25A, T _J = 125°C		2.6	3.3	1	
9 _{FS}	Forward Transconductance	$V_{DD} = 5V, I_D = 25A$		137		S	
	Characteristics			1			
C _{iss}	Characteristics Input Capacitance			5415	7205	pF	
C	Output Capacitance	- V _{DS} = 20V, V _{GS} = 0V,		1470	1955	pF	
C _{oss}	Reverse Transfer Capacitance	f = 1MHz		1470	250	pF	
C _{rss} R _g	Gate Resistance	f = 1MHz	0.1	1.4	3.1	Ω	
-	Characteristics		-				
t _{d(on)}	Turn-On Delay Time			19	35	ns	
t _r	Rise Time	V _{DD} = 20V, I _D = 25A,		9	19	ns	
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10V, R_{GEN} = 6\Omega$		48	78	ns	
t _f	Fall Time			7	14	ns	
Q _g	Total Gate Charge	V _{GS} = 0V to 10V		78	110	nC	
Q _g	Total Gate Charge	$V_{GS} = 0V \text{ to } 4.5V$ $V_{DD} = 20V,$		36	51	nC	
Q _{gs}	Gate to Source Charge	$I_{\rm D} = 25A$		15	-	nC	
Q _{gd}	Gate to Drain "Miller" Charge			10		nC	
	-						
Drain-Sol	Irce Diode Characteristics				10		
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = 25A$ (Note 2)		0.8	1.3	v	
	Devene Deserver Time	$V_{GS} = 0V, I_S = 2.1A$ (Note 2)		0.7	1.2		
t _{rr}	Reverse Recovery Time	— I _F = 25A, di/dt = 100A/μs		53	85	ns	
Q _{rr}	Reverse Recovery Charge			40	64	nC	
Q _{rr}	Reverse Recovery Charge ined with the device mounted on a 1in ² pad 2 oz copper par rd design. a. 50°C/W when mo 1 in ² pad of 2 oz	d on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta JC}$ is pounted on a	b. 125°C/\	40 by design wh V when moun m pad of 2 oz	ted on a		

2. Pulse Test: Pulse Width < 300μ s, Duty cycle < 2.0%.

3. Starting T_J = 25°C, L = 3mH, I_{AS} = 24A, V_{DD} = 40V, V_{GS} = 10V

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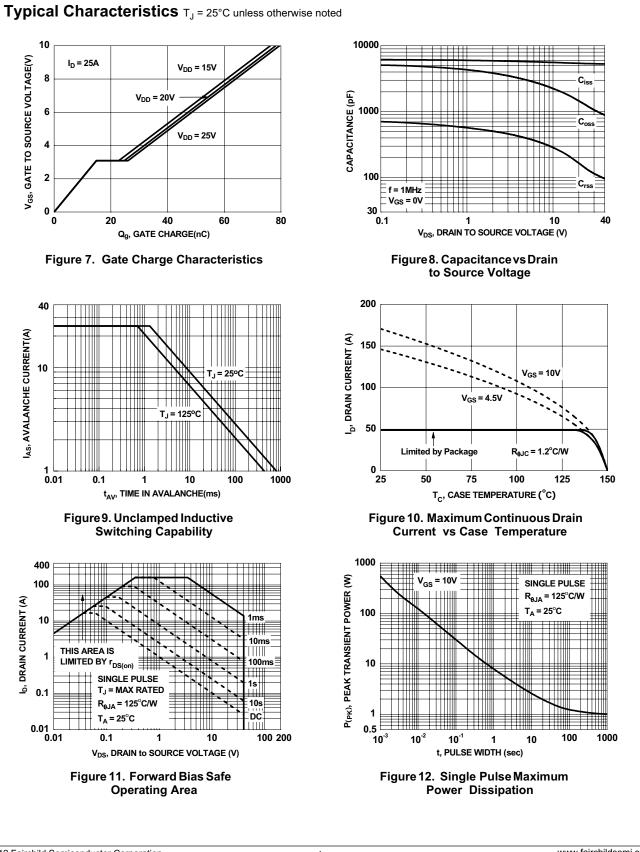
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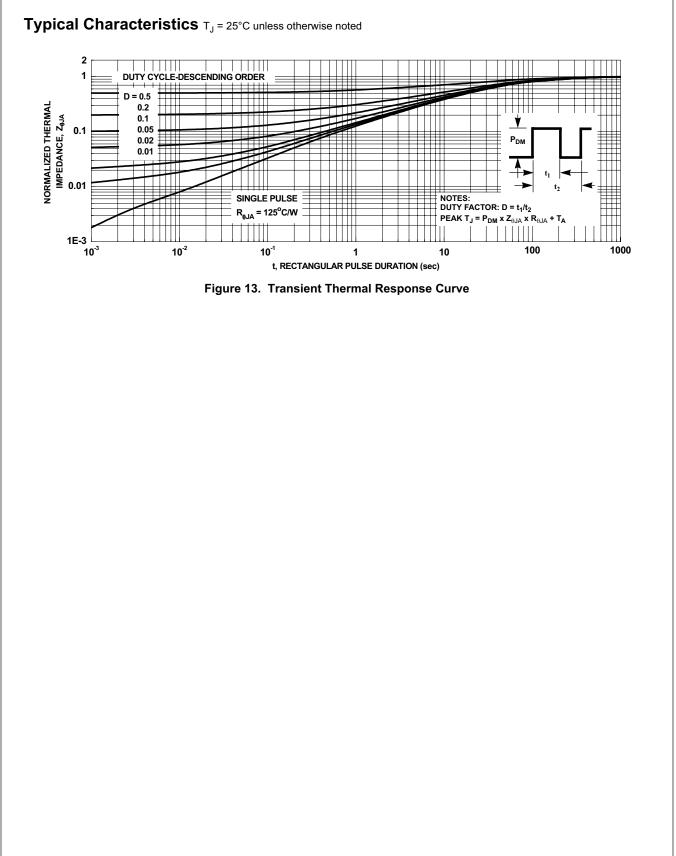
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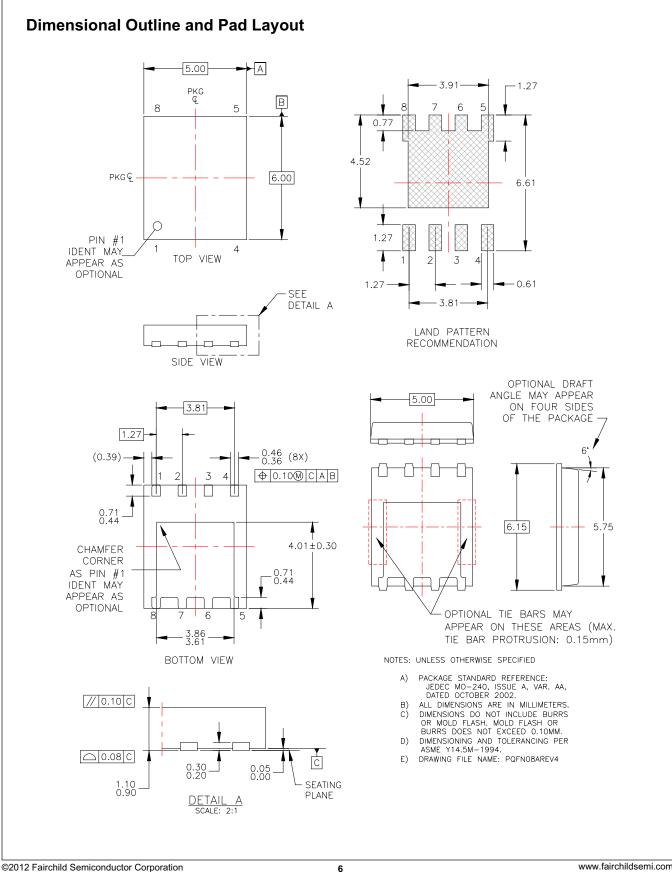
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